



OKI Semiconductor

FEDR27T12800J-02-07 Issue Date: Jul. 9, 2004

MR27T12800J

admatec

8M-Word × 16-Bit or 16M-Word × 8-Bit P2ROM

FEATURES

 $\cdot 8,388,608$ -word \times 16-bit/16,777,216-word \times 8-bit electrically switchable configuration

- · Access time
 - · MR27T12800J-xxxTN, MR27T12800J-xxxTY
 - · 2.7 V to 3.6 V power supply 90 ns MAX
 - · MR27T12800J-xxxTNE, MR27T12800J-xxxTYE
 - · 2.7 V to 3.0 V power supply 120 ns MAX
 - · 3.0 V to 3.6 V power supply 100 ns MAX
- · Operating current 25 mA MAX(5MHz)
- · Standby current 10 µA MAX
- · Input/Output TTL compatible
- · Three-state output

PACKAGES

- · MR27T12800J-xxxTN , MR27T12800J-xxxTNE 48-pin plastic TSOP (TSOP I 48-P-1220-0.50-1K)
- · MR27T12800J-xxxTY, MR27T12800J-xxxTYE 48-pin plastic TSOP (TSOP I 48-P-1220-0.50-L)

P2ROM ADVANCED TECHNOLOGY

P2ROM stands for Production Programmed ROM. This exclusive Oki technology utilizes factory test equipment for programming the customers code into the P2ROM prior to final production testing. Advancements in this technology allows production costs to be equivalent to MASKROM and has many advantages and added benefits over the other non-volatile technologies, which include the following;

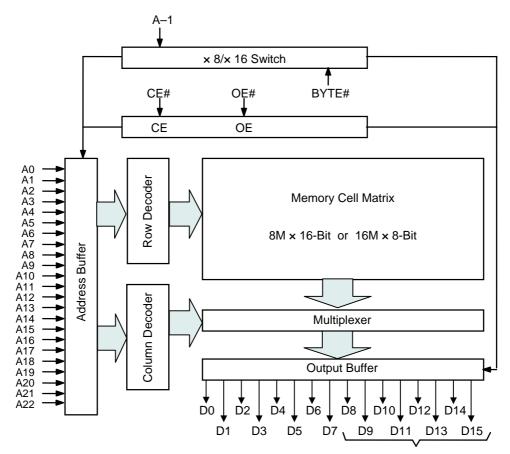
- Short lead time, since the P2ROM is programmed at the final stage of the production process, a large P2ROM inventory "bank system" of un-programmed packaged products are maintained to provide an aggressive lead-time and minimize liability as a custom product.
- No mask charge, since P2ROMs do not utilize a custom mask for storing customer code, no mask charges apply.
- No additional programming charge, unlike Flash and OTP that require additional programming and handling costs, the P2ROM already has the code loaded at the factory with minimal effect on the production throughput. The cost is included in the unit price.
- Custom Marking is available at no additional charge.
- · Pin Compatible with Mask ROM



PIN CONFIGURATION (TOP VIEW) MR27T12800J-xxxTN MR27T12800J-xxxTNE BYTF# 48 Vss A16 47 Vss A15 46 D15/A-1 A14 45 D7 44 D14 A13 43 D6 A12 42 D13 A11 41 D5 A10 40 D12 Α9 39 D4 Α8 A19 38 V_{CC} A21 12 37 V_{CC} 36 A22 A20 35 D11 A18 34 D3 A17 33 D10 Α7 32 D2 A6 31 D9 A5 30 D1 A4 29 D8 28 D0 A3 20 A2 A1 22 27 OE # A0 26 Vss 25 Vss CE# MR27T12800J-xxxTY MR27T12800J-xxxTYE BYTE# Vss 47 Vss 2 A16 D15/A-1 A15 D7 A14 D14 A13 D6 A12 D13 A11 D5 41 A10 D12 Α9 D4 10 **A8** V_{CC} A19 V_{CC} A21 A22 D11 A18 D3 15 A17 D10 16 Α7 17 D2 A6 D9 18 D1 19 A4 20 D8 29 А3 D0 A2 27 OF# Α1 Vss 48TSOP(Type



BLOCK DIAGRAM



In 8-bit output mode, these pins are placed in a high-Z state and pin D15 functions as the A-1 address pin.

PIN DESCRIPTIONS

Pin name	Functions			
D15 / A-1	Data output / Address input			
A0 to A22	Address inputs			
D0 to D14	Data outputs			
CE#	Chip enable input			
OE#	Output enable input			
BYTE#	Word / Byte select input			
V _{CC}	Power supply voltage			
Vss	Ground			



FUNCTION TABLE

Mode	CE#	OE#	BYTE#	V _{CC}	D0 to D7	D8 to D14	D15/A-1		
Read (16-Bit)	L	L	Н			D _{OUT}			
Read (8-Bit)	L	L	L	0.7./	D _{OUT}	Hi–Z	L/H		
Output disable		- 11	Н	2.7 V		Hi–Z			
Output disable	L	Н	L	to 3.6 V		*			
Otan dlavi	H * H				Н	3.0 V		11: 7	
Standby	Н	*	L			Hi–Z	*		

^{*:} Don't Care (H or L)

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Value	Unit
Operating temperature under bias	Та		0 to 70	°C
Storage temperature	Tstg	_	-55 to 125	°C
Input voltage	VI		-0.5 to V _{CC} +0.5	V
Output voltage	Vo	relative to V _{SS}	-0.5 to V _{CC} +0.5	V
Power supply voltage	Vcc		–0.5 to 5	V
Power dissipation per package	P _D	Ta = 25°C	1.0	W
Output short circuit current	los	_	10	mA

RECOMMENDED OPERATING CONDITIONS

 $(Ta = 0 \text{ to } 70^{\circ}C)$

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
V _{CC} power supply voltage	Vcc		2.7	_	3.6	V
Input "H" level	V _{IH}	$V_{CC} = 2.7 \text{ to } 3.6 \text{ V}$	2.2	_	V _{CC} +0.5*	V
Input "L" level	V_{IL}		-0.5**	_	0.6	V

Voltage is relative to V_{SS}.

- * : Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.
- **: -1.5V(Min.) when pulse width of undershoot is less than 10ns.

PIN CAPACITANCE

 $(V_{CC} = 3.0 \text{ V}, \text{Ta} = 25^{\circ}\text{C}, \text{f} = 1 \text{ MHz})$

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input	C _{IN1}	V _I = 0 V	_	_	8	
BYTE#	C _{IN2}	V ₁ = 0 V	_	_	200	pF
Output	C _{OUT}	$V_O = 0 V$	_	_	10	



ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS

 $(V_{CC} = 2.7 \text{ to } 3.6 \text{ V}, \text{ Ta} = 0 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input leakage current	ILI	$V_I = 0$ to V_{CC}	_	_	5	μΑ
Output leakage current	I _{LO}	$V_O = 0$ to V_{CC}	_	_	5	μΑ
V _{CC} power supply current	Iccsc	CE# = V _{CC}	_	_	10	μΑ
(Standby)	I _{CCST}	CE# = V _{IH}	_	_	1	mA
V _{CC} power supply current		$CE\# = V_{IL}, OE\# = V_{IH}$			25	m Λ
(Read)	I _{CCA}	f=5MHz			25	mA
Input "H" level	V _{IH}	_	2.2	_	V _{CC} +0.5*	V
Input "L" level	V _{IL}	_	-0.5**	_	0.6	V
Output "H" level	V _{OH}	$I_{OH} = -1 \text{ mA}$	2.4	_	_	V
Output "L" level	V _{OL}	$I_{OL} = 2 \text{ mA}$	_	_	0.4	V

Voltage is relative to V_{SS}.

^{* :} Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.

^{**: -1.5}V(Min.) when pulse width of undershoot is less than 10ns.



AC CHARACTERISTICS

- MR27T12800J-xxxTN, MR27T12800J-xxxTY

1	$V_{CC} =$	27	' to	36	3 V	Ta =	0 to	709	(:)
١	v (:(: -	∠ .1	w	٥.,	υv.	ıa –	UIU	70	\mathbf{c}

Parameter	Symbol	Condition	Min.	Max.	Unit
Address cycle time	t _C		90	_	ns
Address access time	t _{ACC}	CE# = OE# = V _{IL}		90	ns
CE# access time	t _{CE}	$OE# = V_{IL}$		90	ns
OE# access time	toE	CE# = V _{IL}		30	ns
Output disable time	t _{CHZ}	$OE# = V_{IL}$	0	20	ns
Output disable time	t _{OHZ}	CE# = V _{IL}	0	20	ns
Output hold time	toH	CE# = OE# = V _{IL}	0	_	ns

- MR27T12800J-xxxTNE, MR27T12800J-xxxTYE

 $(V_{CC} = 2.7 \text{ to } 3.6 \text{ V}, \text{ Ta} = 0 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Condition	Min.	Max.	Unit	
Address cycle time	+-		120(V _{CC} = 2.7 to 3.0 V)		ne	
Address cycle line	t _C		$100(V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$	_	ns	
Address access time		CE# = OE# = V _{II}		$120(V_{CC} = 2.7 \text{ to } 3.0 \text{ V})$	no	
Address access time	t _{ACC}	0E# = 0E# = V _{IL}	_	$100(V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$	ns	
CE# access time		OF# V		$120(V_{CC} = 2.7 \text{ to } 3.0 \text{ V})$		
CE# access time	t _{CE}	OE# = V _{IL}	_	$100(V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$	ns	
OE# access time	t _{OE}	CE# = V _{IL}	_	30	ns	
Output disable time	t _{CHZ}	OE# = V _{IL}	0	20	ns	
Output disable time	t _{OHZ}	CE# = V _{IL}	0	20	ns	
Output hold time	t _{OH}	CE# = OE# = V _{IL}	0	_	ns	

Measurement conditions

Input signal level ------0 V/3 V Input timing reference level------50 pF Output timing reference level ------1/2Vcc

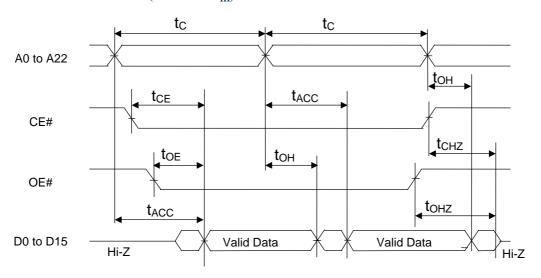
Output load



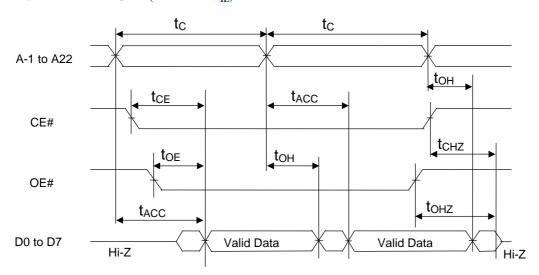


TIMING CHART (READ CYCLE)

16-Bit READ MODE (BYTE# = V_{IH})



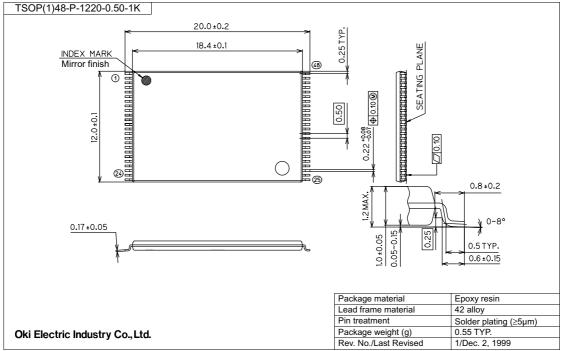
8-BIT READ MODE (BYTE# = V_{IL})





PACKAGE DIMENSIONS

(Unit: mm)



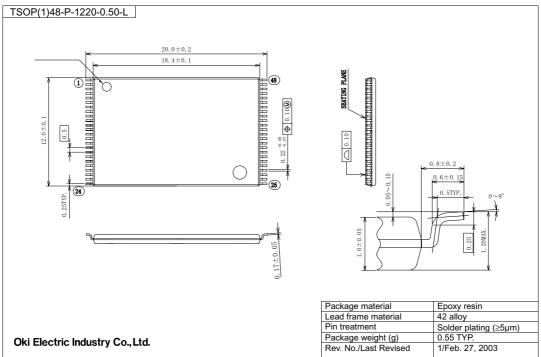
Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage.

Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).



(Unit: mm)



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REVISION HISTORY

Document		Page		
No.	Date	Previous Edition	Current Edition	Description
FEDR27T12800J-02-01	July. 2002	ı	ı	
FEDR27T12800J-02-02	Jan. 2003	1, 5	1, 5	Change tC, tACC, tCE to 120ns
FEDR27T12800J-02-03	Jan. 2003	1	1	Added P/N to MR27T12800J-xxxTNE
FEDR27T12800J-02-04	Feb. 2003	1, 5	1, 5	Added MR27T12800J-xxxTY
FEDR27T12800J-02-05	Mar. 10, 2003	1, 5	1, 5	1.Change tC, tACC, tCE to 90ns(MR27T12800J-xxxTY) 2. Added MR27T12800J-xxxTYE
FEDR27T12800J-02-06	Jun. 4, 2003	3, 4, 5	3, 4, 5	Change Ta to 0°C
FEDR27T12800J-02-07	Jul. 9, 2004	3	3	Add P _D condition and I _{OS} = 10mA



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